

CONTROLLED AVALANCHE RECTIFIER DIODES

Silicon diodes in a DO-5 metal envelope, capable of absorbing transients and intended for power rectifier applications.

The series consists of the following types:

Normal polarity (cathode to stud): BYX56-600 to BYX56-1400.

Reverse polarity (anode to stud): BYX56-600R to BYX56-1400R.

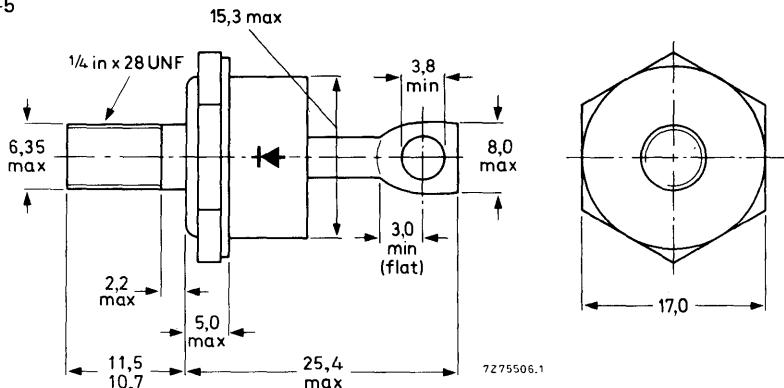
QUICK REFERENCE DATA

		BYX56-600(R)	800(R)	1000(R)	1200(R)	1400(R)	
Crest working reverse voltage	V _{RWM}	max.	600	800	1000	1200	1400 V
Reverse avalanche breakdown voltage	V _{(BR)R}	>	750	1000	1250	1450	1650 V
Average forward current	I _{F(AV)}	max.			48		A
Non-repetitive peak forward current	I _{FSM}	max.			800		A
Non-repetitive peak reverse power dissipation	P _{RSR}	max.			40		kW

MECHANICAL DATA

Dimensions in mm

Fig. 1 DO-5



Net mass: 22 g

Diameter of clearance hole: max. 6.5 mm

Accessories supplied on request:

56264A (mica washer, insulating ring, tag).

Supplied with device: 1 nut, 1 lock washer.

Nut dimensions across the flats: 11.1 mm.

The mark shown applies to normal polarity types.

Torque on nut:

min. 1.7 Nm (17 kg cm),

max. 2.5 Nm (25 kg cm).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC134)

→ Voltages*	BYX56-600(R)	800(R)	1000(R)	1200(R)	1400(R)	
Crest working reverse voltage V_{RWM}	max.	600	800	1000	1200	1400 V
Continuous reverse voltage V_R	max.	600	800	1000	1200	1400 V
↓						
Currents						
Average forward current (averaged over any 20 ms period)						
up to $T_{mb} = 112^\circ\text{C}$		$I_F(\text{AV})$	max.	48	A	
at $T_{mb} = 125^\circ\text{C}$		$I_F(\text{AV})$	max.	40	A	
R.M.S. forward current		$I_F(\text{RMS})$	max.	75	A	
Repetitive peak forward current		I_{FRM}	max.	450	A	
Non-repetitive peak forward current $t = 10 \text{ ms}$ (half sine-wave); $T_j = 175^\circ\text{C}$ prior to surge; with reapplied $V_{RWM\text{max}}$		I_{FSM}	max.	800	A	
$I^2 t$ for fusing ($t \leq 10 \text{ ms}$)		$I^2 t$	max.	3200	A^2s	
Reverse power dissipation						
Repetitive peak reverse power dissipation $t = 10 \mu\text{s}$ (square-wave; $f = 50 \text{ Hz}$); $T_j = 175^\circ\text{C}$		P_{RRM}	max.	6.5	kW	
Non-repetitive peak reverse power dissipation $t = 10 \mu\text{s}$ (square-wave) $T_j = 25^\circ\text{C}$ prior to surge $T_j = 175^\circ\text{C}$ prior to surge		P_{RSM}	max.	40	kW	
		P_{RSM}	max.	6.5	kW	
Temperatures						
Storage temperature	T_{stg}		–55 to +175		$^\circ\text{C}$	
Junction temperature	T_j	max.	175		$^\circ\text{C}$	
THERMAL RESISTANCE						
From junction to mounting base	$R_{th j-mb}$	=	0.8	$^\circ\text{C/W}$		
From mounting base to heatsink	$R_{th mb-h}$	=	0.2	$^\circ\text{C/W}$		
Transient thermal impedance; $t = 1 \text{ ms}$	$Z_{th j-h}$	=	0.03	$^\circ\text{C/W}$		

*To ensure thermal stability: $R_{th j-a} < 2.2 \text{ }^\circ\text{C/W}$ (a.c.)

CHARACTERISTICS

	BYX56-600(R)	800(R)	1000(R)	1200(R)	1400(R)	←
Forward voltage $I_F = 150 \text{ A}; T_j = 25^\circ\text{C}$ V_F	<	1.8	1.8	1.8	1.8	1.8 V*
Reverse avalanche breakdown voltage $I_R = 5 \text{ mA}; T_j = 25^\circ\text{C}$ $V_{(BR)R}$	>	750	1000	1250	1450	1650 V
Reverse current $V_R = V_{RW\text{Mmax}}$; $T_j = 125^\circ\text{C}$ I_R	<	2000	2000	2000	2200	2400 mA

OPERATING NOTES

The top connector should neither be bent nor twisted; it should be soldered into the circuit so that there is no strain on it.

During soldering the heat conduction to the junction should be kept to a minimum by using a thermal shunt.

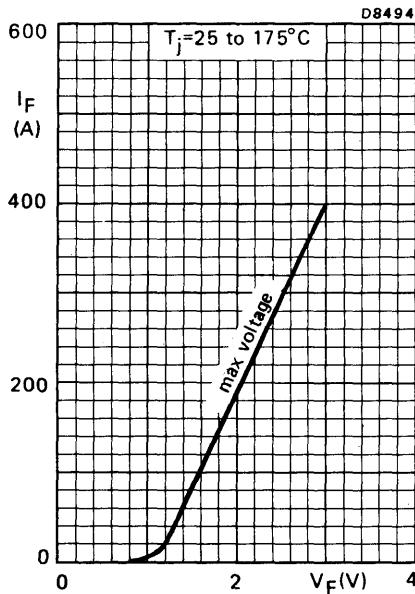


Fig.2

*Measured under pulsed conditions to avoid excessive dissipation.

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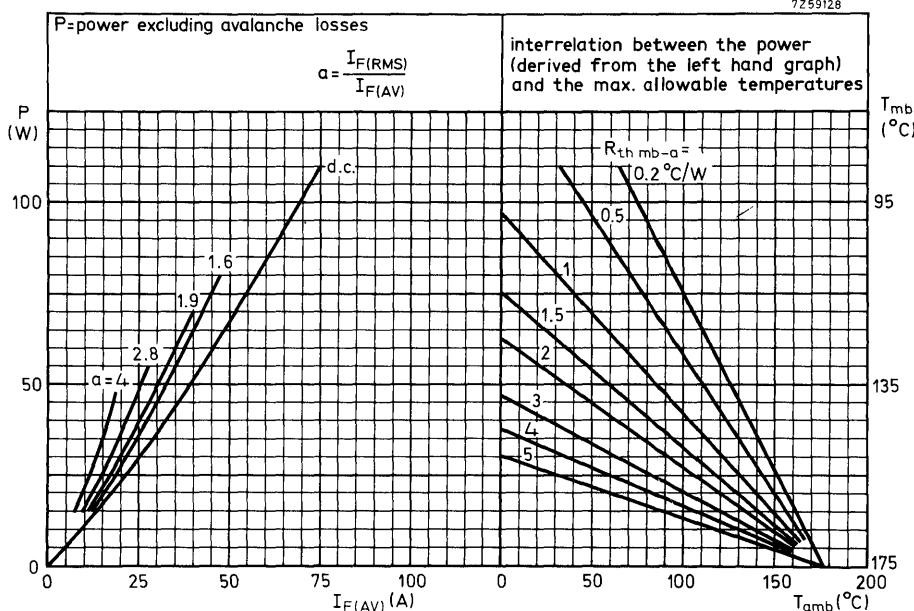


Fig.3

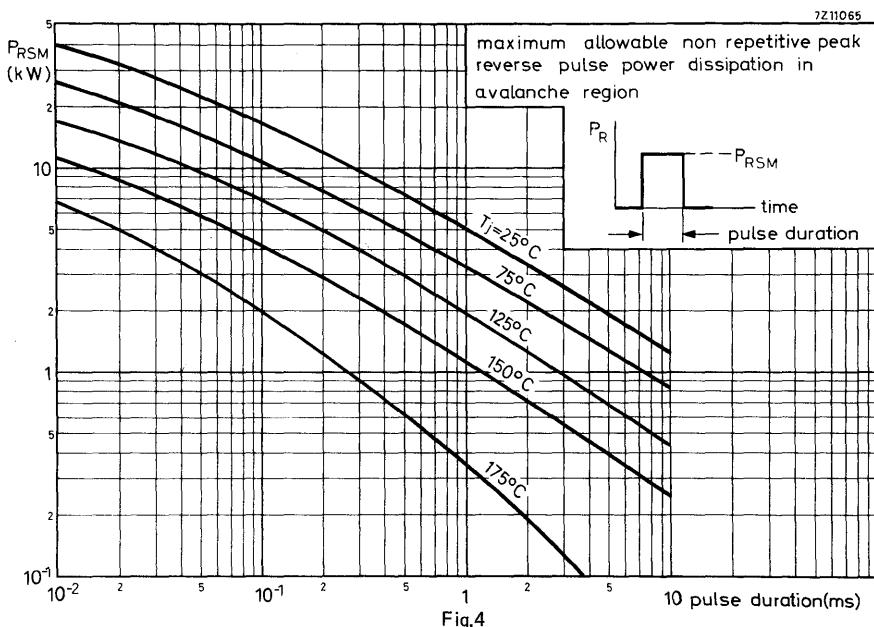


Fig.4

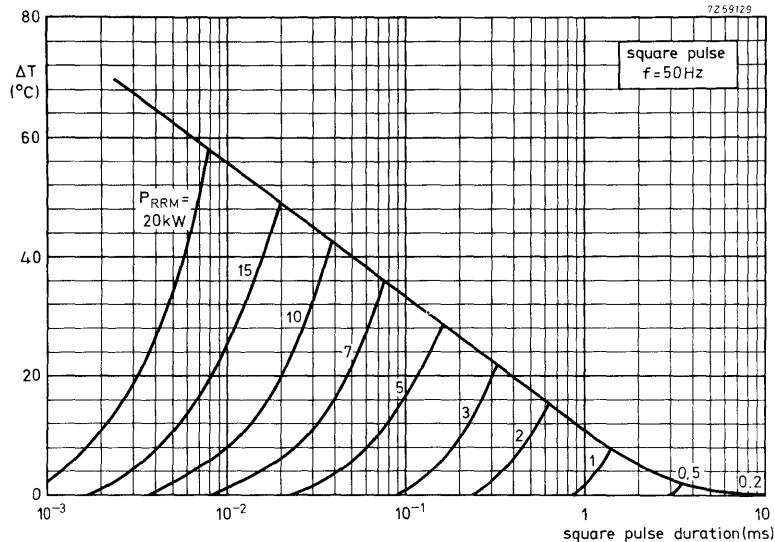


Fig.5

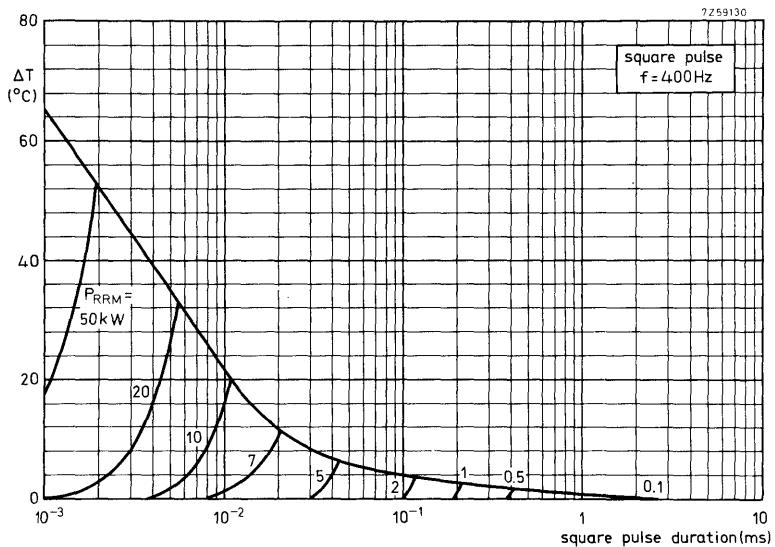


Fig.6

ΔT = necessary derating of $T_{j\max}$ to accommodate repetitive transients in the reverse direction.
Allowance can be made for this by assuming the ambient temperature ΔT higher.

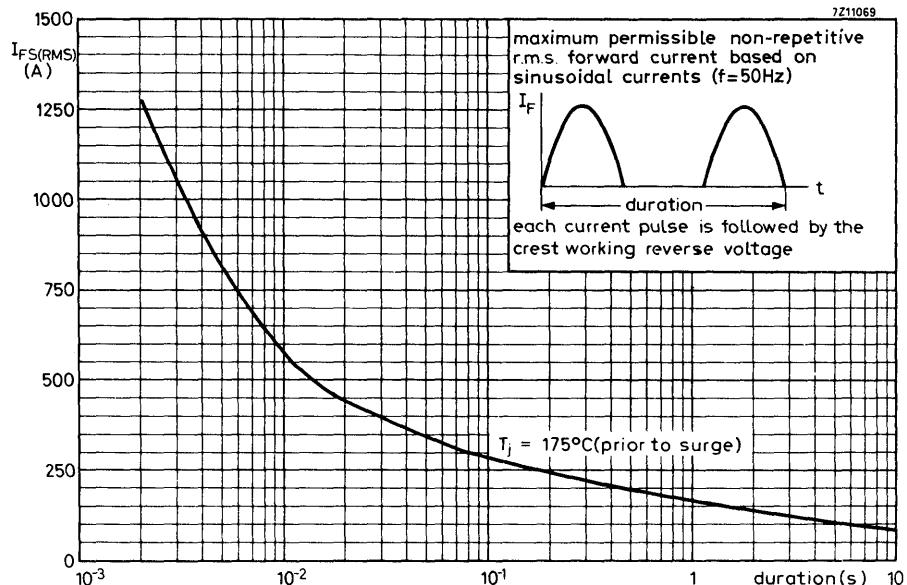


Fig. 7

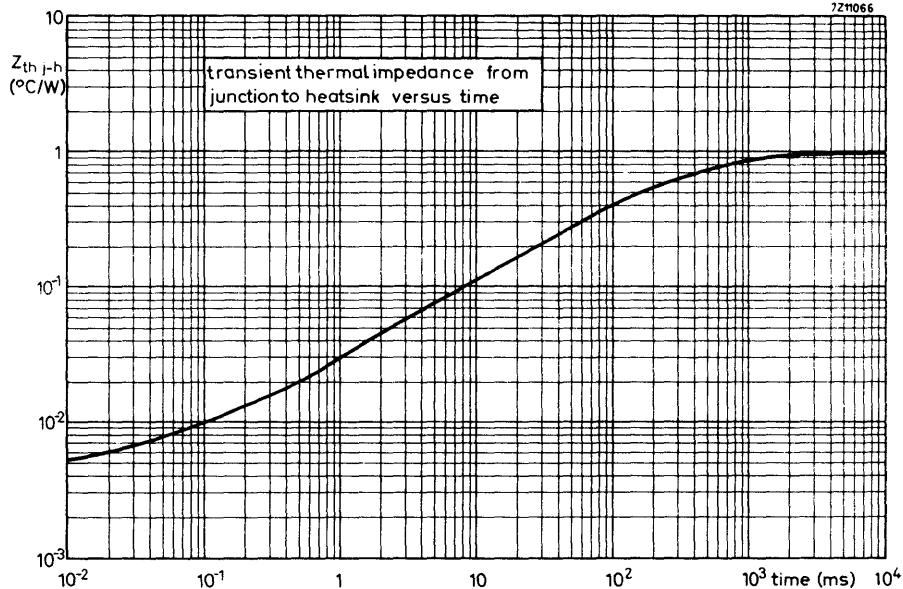


Fig. 8